- Member of the Texas Instruments Widebus ${ }^{\text {TM }}$ Family
- EPIC ${ }^{\text {TM }}$ (Enhanced-Performance Implanted CMOS) Submicron Process
- ESD Protection Exceeds 2000 V Per MIL-STD-883, Method 3015; Exceeds 200 V Using Machine Model ( $C=200 \mathrm{pF}, \mathrm{R}=0$ )
- Latch-Up Performance Exceeds 250 mA Per JESD 17
- Bus Hold on Data Inputs Eliminates the Need for External Pullup/Pulldown Resistors
- Package Options Include Plastic 300-mil Shrink Small-Outline (DL) and Thin Shrink Small-Outline (DGG) Packages


## description

This 20-bit bus-interface flip-flop is designed for $1.65-\mathrm{V}$ to $3.6-\mathrm{V} \mathrm{V}_{\mathrm{CC}}$ operation.
The SN74ALVCH16821 can be used as two 10-bit flip-flops or one 20 -bit flip-flop. The 20 flip-flops are edge-triggered D-type flip-flops. On the positive transition of the clock (CLK) input, the device provides true data at the Q outputs.
A buffered output-enable ( $\overline{\mathrm{OE}}$ ) input can be used to place the ten outputs in either a normal logic state (high or low logic levels) or the high-impedance state. In the high-impedance state, the outputs neither load nor drive the bus lines significantly. The high-impedance state and increased drive provide the capability to drive bus lines without need for interface or pullup components.
$\overline{\mathrm{OE}}$ does not affect the internal operation of the flip-flops. Old data can be retained or new data can be entered while the outputs are in the high-impedance state.
To ensure the high-impedance state during power up or power down, $\overline{\mathrm{OE}}$ should be tied to $\mathrm{V}_{\mathrm{CC}}$ through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.
Active bus-hold circuitry is provided to hold unused or floating data inputs at a valid logic level.
The SN74ALVCH16821 is characterized for operation from $-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$.

## SN74ALVCH16821

## 3.3-V 20-BIT BUS-INTERFACE FLIP-FLOP

WITH 3-STATE OUTPUTS
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FUNCTION TABLE
(each 10-bit flip-flop)

| INPUTS |  |  | OUTPUT |
| :---: | :---: | :---: | :---: |
| $\overline{\mathbf{O E}}$ | CLK | $\mathbf{D}$ | $\mathbf{Q}$ |
| L | $\uparrow$ | $H$ | $H$ |
| L | $\uparrow$ | L | L |
| L | H or L | X | $\mathrm{Q}_{0}$ |
| H | X | X | Z |

## logic symbol $\dagger$


$\dagger$ This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

## logic diagram (positive logic)



To Nine Other Channels

## absolute maximum ratings over operating free-air temperature range (unless otherwise noted) $\dagger$

$$
\begin{aligned}
& \text { Supply voltage range, } \mathrm{V}_{\mathrm{CC}} \ldots . . \ldots . . . \text {. . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . }-0.5 \mathrm{~V} \text { to } 4.6 \mathrm{~V} \\
& \text { Input voltage range, } \mathrm{V}_{\mathrm{I}} \text { (see Note 1) . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . } 0.5 \mathrm{~V} \text {. to } 4.6 \mathrm{~V} \\
& \text { Output voltage range, } \mathrm{V}_{\mathrm{O}} \text { (see Notes } 1 \text { and 2) . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . }-0.5 \mathrm{~V} \text { to } \mathrm{V}_{\mathrm{CC}}+0.5 \mathrm{~V} \\
& \text { Input clamp current, } \mathrm{I}_{\mathrm{IK}}\left(\mathrm{~V}_{\mathrm{I}}<0\right) \text {. . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . }-50 \mathrm{~mA} \\
& \text { Output clamp current, } \mathrm{I}_{\mathrm{OK}}\left(\mathrm{~V}_{\mathrm{O}}<0\right) \ldots . . . . . \text {. . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . } 50 \mathrm{~mA} \\
& \text { Continuous output current, } \mathrm{I}_{\mathrm{O}} \text {. . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . } \pm 50 \mathrm{~mA} \\
& \text { Continuous current through each } \mathrm{V}_{\mathrm{CC}} \text { or GND . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . } \pm 100 \mathrm{~mA} \\
& \text { Package thermal impedance, } \theta_{J A} \text { (see Note 3): DGG package . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . 81 } 8{ }^{\circ} \mathrm{C} / \mathrm{W} \\
& \text { DL package . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . } 74^{\circ} \mathrm{C} / \mathrm{W} \\
& \text { Storage temperature range, } T_{\text {stg }} \\
& -65^{\circ} \mathrm{C} \text { to } 150^{\circ} \mathrm{C} \\
& \dagger \text { Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and } \\
& \text { functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not } \\
& \text { implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability. } \\
& \text { NOTES: 1. The input negative-voltage and output voltage ratings may be exceeded if the input and output current ratings are observed. } \\
& \text { 2. This value is limited to } 4.6 \mathrm{~V} \text { maximum. } \\
& \text { 3. The package thermal impedance is calculated in accordance with JESD } 51 .
\end{aligned}
$$

## 3.3-V 20-BIT BUS-INTERFACE FLIP-FLOP

WITH 3-STATE OUTPUTS
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## recommended operating conditions (see Note 4)

|  |  |  | MIN | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\mathrm{CC}}$ | Supply voltage |  | 1.65 | 3.6 | V |
| $\mathrm{V}_{\mathrm{IH}}$ | High-level input voltage | $\mathrm{V}_{\mathrm{CC}}=1.65 \mathrm{~V}$ to 1.95 V | $0.65 \times \mathrm{V}_{\mathrm{CC}}$ |  | V |
|  |  | $\mathrm{V}_{\mathrm{CC}}=2.3 \mathrm{~V}$ to 2.7 V | 1.7 |  |  |
|  |  | $\mathrm{V}_{\mathrm{CC}}=2.7 \mathrm{~V}$ to 3.6 V | 2 |  |  |
| $\mathrm{V}_{\mathrm{IL}}$ | Low-level input voltage | $\mathrm{V}_{\mathrm{CC}}=1.65 \mathrm{~V}$ to 1.95 V |  | $0.35 \times \mathrm{V}_{\mathrm{CC}}$ | V |
|  |  | $\mathrm{V}_{\mathrm{CC}}=2.3 \mathrm{~V}$ to 2.7 V |  | 0.7 |  |
|  |  | $\mathrm{V}_{\mathrm{CC}}=2.7 \mathrm{~V}$ to 3.6 V |  | 0.8 |  |
| $\mathrm{V}_{1}$ | Input voltage |  | 0 | $\mathrm{V}_{\mathrm{CC}}$ | V |
| $\mathrm{V}_{\mathrm{O}}$ | Output voltage |  | 0 | $\mathrm{V}_{\mathrm{CC}}$ | V |
| IOH | High-level output current | $\mathrm{V}_{\mathrm{CC}}=1.65 \mathrm{~V}$ |  | -4 | mA |
|  |  | $\mathrm{V}_{\mathrm{CC}}=2.3 \mathrm{~V}$ |  | -12 |  |
|  |  | $\mathrm{V}_{\mathrm{CC}}=2.7 \mathrm{~V}$ |  | -12 |  |
|  |  | $\mathrm{V}_{\mathrm{CC}}=3 \mathrm{~V}$ |  | -24 |  |
| ${ }^{\text {IOL}}$ | Low-level output current | $\mathrm{V}_{\mathrm{CC}}=1.65 \mathrm{~V}$ |  | 4 | mA |
|  |  | $\mathrm{V}_{\mathrm{CC}}=2.3 \mathrm{~V}$ |  | 12 |  |
|  |  | $\mathrm{V}_{\mathrm{CC}}=2.7 \mathrm{~V}$ |  | 12 |  |
|  |  | $\mathrm{V}_{\mathrm{CC}}=3 \mathrm{~V}$ |  | 24 |  |
| $\Delta t / \Delta \mathrm{v}$ | Input transition rise or fall rate |  |  | 10 | ns/V |
| $\mathrm{T}_{\mathrm{A}}$ | Operating free-air temperature |  | -40 | 85 | ${ }^{\circ} \mathrm{C}$ |

NOTE 4: All unused control inputs of the device must be held at $\mathrm{V}_{\mathrm{CC}}$ or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.
electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

$\dagger$ All typical values are at $\mathrm{V}_{\mathrm{CC}}=3.3 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.
$\ddagger$ This is the bus-hold maximum dynamic current. It is the minimum overdrive current required to switch the input from one state to another.
timing requirements over recommended operating free-air temperature range (unless otherwise noted) (see Figures 1 through 3)

|  |  | $\mathrm{V}_{\mathrm{CC}}=1.8 \mathrm{~V}$ | $\begin{gathered} \mathrm{V}_{\mathrm{CC}}=2.5 \mathrm{~V} \\ \pm 0.2 \mathrm{~V} \end{gathered}$ |  | $\mathrm{V}_{\mathrm{CC}}=2.7 \mathrm{~V}$ |  | $\begin{gathered} \mathrm{V}_{\mathrm{CC}}=3.3 \mathrm{~V} \\ \pm 0.3 \mathrm{~V} \end{gathered}$ |  | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | MIN MAX | MIN | MAX | MIN | MAX | MIN | MAX |  |
| $\mathrm{f}_{\text {clock }}$ | Clock frequency | § |  | 150 |  | 150 |  | 150 | MHz |
| $\mathrm{t}_{\mathrm{w}}$ | Pulse duration, CLK high or low | § | 3.3 |  | 3.3 |  | 3.3 |  | ns |
| $\mathrm{t}_{\text {su }}$ | Setup time, data before CLK $\uparrow$ | § | 4.4 |  | 3.9 |  | 3.4 |  | ns |
| $\mathrm{th}_{\mathrm{h}}$ | Hold time, data after CLK $\uparrow$ | § | 0 |  | 0 |  | 0 |  | ns |

§ This information was not available at the time of publication.

## 3.3-V 20-BIT BUS-INTERFACE FLIP-FLOP

## WITH 3-STATE OUTPUTS

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switching characteristics over recommended operating free-air temperature range (unless otherwise noted) (see Figures 1 through 3)

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | $\mathrm{V}_{\mathrm{CC}}=1.8 \mathrm{~V}$ | $\begin{gathered} \mathrm{V}_{\mathrm{CC}}=2.5 \mathrm{~V} \\ \pm 0.2 \mathrm{~V} \end{gathered}$ |  | $\mathrm{V}_{\mathrm{CC}}=2.7 \mathrm{~V}$ |  | $\begin{gathered} \mathrm{V}_{\mathrm{CC}}=3.3 \mathrm{~V} \\ \pm 0.3 \mathrm{~V} \end{gathered}$ |  | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN TYP | MIN | MAX | MIN | MAX | MIN | MAX |  |
| $f_{\text {max }}$ |  |  | $\dagger$ | 150 |  | 150 |  | 150 |  | MHz |
| $t_{\text {pd }}$ | CLK | Q | $\dagger$ | 1 | 5.8 |  | 5.3 | 1 | 4.5 | ns |
| ten | $\overline{\mathrm{OE}}$ | Q | $\dagger$ | 1 | 6.6 |  | 6.2 | 1 | 5.1 | ns |
| $\mathrm{t}_{\text {dis }}$ | $\overline{\mathrm{OE}}$ | Q | $\dagger$ | 1 | 5.7 |  | 5 | 1 | 4.6 | ns |

$\dagger$ This information was not available at the time of publication.
operating characteristics, $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$

| PARAMETER |  |  | TEST CONDITIONS |  | $\mathrm{V}_{\text {CC }}=1.8 \mathrm{~V}$ | $\mathrm{V}_{\text {CC }}=2.5 \mathrm{~V}$ | $\mathrm{V}_{\text {CC }}=3.3 \mathrm{~V}$ | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | TYP | TYP | TYP |  |
| $\mathrm{C}_{\mathrm{pd}}$ | Power dissipation capacitance | Outputs enabled |  |  | $C_{L}=50 \mathrm{pF}, \quad \mathrm{f}=10 \mathrm{MHz}$ |  | $\dagger$ | 36 | 40 | pF |
|  |  | Outputs disabled | $\dagger$ | 22 |  |  | 24 |  |  |

[^0]
## PARAMETER MEASUREMENT INFORMATION $\mathrm{V}_{\mathrm{CC}}=1.8 \mathrm{~V}$



| TEST | $\mathbf{S 1}$ |
| :---: | :---: |
| $\mathrm{t}_{\text {pd }}$ | Open |
| $\mathrm{tPLZ}^{\prime} / \mathrm{tPZL}$ | $2 \times \mathrm{V}_{\mathbf{C C}}$ |
| $\mathrm{t}_{\mathrm{PHZ}} / \mathrm{t}_{\mathrm{PZH}}$ | GND |

## LOAD CIRCUIT



VOLTAGE WAVEFORMS
SETUP AND HOLD TIMES

> VOLTAGE WAVEFORMS
> PROPAGATION DELAY TIMES


VOLTAGE WAVEFORMS
PULSE DURATION


> VOLTAGE WAVEFORMS
> ENABLE AND DISABLE TIMES

NOTES: A. $\mathrm{C}_{\mathrm{L}}$ includes probe and jig capacitance.
B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control.

Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
C. All input pulses are supplied by generators having the following characteristics: $\mathrm{PRR} \leq 10 \mathrm{MHz}, \mathrm{Z}_{\mathrm{O}}=50 \Omega, \mathrm{t}_{\mathrm{r}} \leq 2 \mathrm{~ns}, \mathrm{t}_{\mathrm{f}} \leq 2 \mathrm{~ns}$.
D. The outputs are measured one at a time with one transition per measurement.
E. $t_{P L Z}$ and $t_{P H Z}$ are the same as $t_{\text {dis }}$.
F. tPZL and tPZH are the same as ten.
G. $t_{P L H}$ and $t_{P H L}$ are the same as $t_{p d}$.

Figure 1. Load Circuit and Voltage Waveforms

$$
\mathrm{V}_{\mathrm{CC}}=2.5 \mathrm{~V} \pm 0.2 \mathrm{~V}
$$



| TEST | S1 |
| :---: | :---: |
| $\mathrm{t}_{\text {pd }}$ | Open |
| $\mathrm{t}_{\text {PLZ }} / \mathrm{tPZL}$ | $2 \times \mathrm{V}_{\text {CC }}$ |
| $\mathrm{t}_{\text {PHZ }} / \mathrm{t}_{\text {PZH }}$ | GND |

## LOAD CIRCUIT

> VOLTAGE WAVEFORMS PROPAGATION DELAY TIMES


VOLTAGE WAVEFORMS PULSE DURATION


VOLTAGE WAVEFORMS
ENABLE AND DISABLE TIMES

NOTES: A. $C_{L}$ includes probe and jig capacitance.
B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
C. All input pulses are supplied by generators having the following characteristics: $\mathrm{PRR} \leq 10 \mathrm{MHz}, \mathrm{Z}_{\mathrm{O}}=50 \Omega, \mathrm{t}_{\mathrm{r}} \leq 2 \mathrm{~ns}, \mathrm{t}_{\mathrm{f}} \leq 2 \mathrm{~ns}$.
D. The outputs are measured one at a time with one transition per measurement.
E. tPLZ and $\mathrm{tPHZ}^{2}$ are the same as $\mathrm{t}_{\text {dis }}$.
F. tpZL and tpZH are the same as ten.
G. tPLH and tPHL are the same as $\mathrm{t}_{\mathrm{pd}}$.

Figure 2. Load Circuit and Voltage Waveforms

## 3.3-V 20-BIT BUS-INTERFACE FLIP-FLOP <br> WITH 3-STATE OUTPUTS <br> SCES037C - JULY 1995 - REVISED FEBRUARY 1999

## PARAMETER MEASUREMENT INFORMATION <br> $\mathrm{V}_{\mathrm{CC}}=2.7 \mathrm{~V}$ AND 3.3 $\mathrm{V} \pm 0.3 \mathrm{~V}$



| TEST | S1 |
| :---: | :---: |
| $\mathbf{t}_{\text {pd }}$ | Open |
| tPLZ $^{\prime}$ PRZL | 6 V |
| tPHZ $^{\text {PPZH }}$ | GND |



VOLTAGE WAVEFORMS PROPAGATION DELAY TIMES


> VOLTAGE WAVEFORMS
> ENABLE AND DISABLE TIMES

NOTES: A. $C_{L}$ includes probe and jig capacitance.
B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
C. All input pulses are supplied by generators having the following characteristics: $\mathrm{PRR} \leq 10 \mathrm{MHz}, \mathrm{Z}_{\mathrm{O}}=50 \Omega, \mathrm{t}_{\mathrm{r}} \leq 2.5 \mathrm{~ns}, \mathrm{t}_{\mathrm{f}} \leq 2.5 \mathrm{~ns}$.
D. The outputs are measured one at a time with one transition per measurement.
E. $t_{P L Z}$ and $t_{P H Z}$ are the same as $t_{\text {dis }}$.
F. $t_{P Z L}$ and $t_{P Z H}$ are the same as $t_{e n}$.
G. tPLH and tPHL are the same as $\mathrm{t}_{\mathrm{pd}}$.

Figure 3. Load Circuit and Voltage Waveforms


| PIM | $\mathbf{2 8}$ | $\mathbf{4 8}$ | $\mathbf{5 6}$ |
| :---: | :---: | :---: | :---: |
| A MAX | 0.380 <br> $(9,65)$ | 0.630 <br> $(16,00)$ | 0.730 <br> $(18,54)$ |
| A MIN | 0.370 <br> $(9,40)$ | 0.620 <br> $(15,75)$ | 0.720 <br> $(18,29)$ |

NOTES: A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. Body dimensions do not include mold flash or protrusion not to exceed $0.006(0,15)$.
D. Falls within JEDEC MO-118

48 PINS SHOWN


NOTES: A. All linear dimensions are in millimeters.
B. This drawing is subject to change without notice.
C. Body dimensions do not include mold protrusion not to exceed 0,15.
D. Falls within JEDEC MO-153

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[^0]:    $\dagger$ This information was not available at the time of publication.

